

RoHS Compliant Product
A suffix of "-C" specifies halogen & lead-free

DESCRIPTION

The SSESD03C is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.

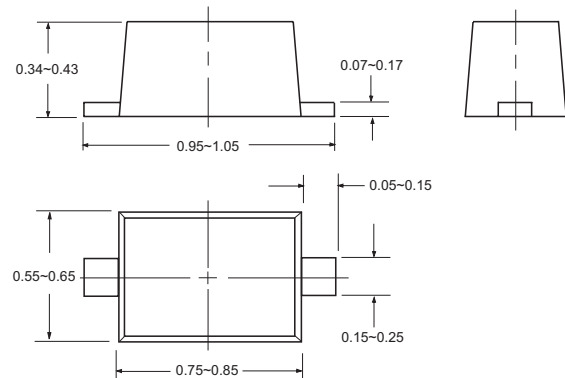
SOD-923

APPLICATIONS

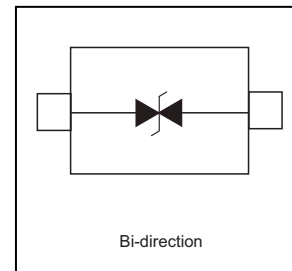
- Cellular phones / audio
- Portable devices
- Digital cameras
- Power supplies

FEATURES

- Small body outline dimensions
- Low body height
- Peak power up to 150 Watts @ 8 x 20 μ s pulse
- Low leakage current
- Response time is typically < 1 ns
- ESD rating of class 3 (> 16 kV) per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- IEC61000-4-4 Level 4 EFT Protection



Dimensions in millimeters



ABSOLUTE RATINGS (Tamb = 25°C)

Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20 \mu$ s)	P_{PP}	150	W
Maximum lead temperature for soldering during 10s	T_L	260	°C
Storage Temperature Range	T_{STG}	-55 to +155	°C
Operating Temperature Range	T_{OP}	-40 to +125	°C
Maximum junction temperature	T_J	150	°C
IEC61000-4-2 (ESD)	Air discharge Contact discharge	± 15 ± 8	KV
IEC61000-4-4 (EFT)		40	A
ESD Voltage	Per Human Body Model	16	KV

ELECTRICAL CHARACTERISTICS

(Ratings at 25°C ambient temperature unless otherwise specified. $V_F = 0.9V$ at $I_F = 10mA$)

Device	V_{RWM} (V)	I_R (μ A) @ V_{RWM}	V_{BR} (V) @ I_T (Note 1)	I_T	V_C (V) @ $I_{PP}=5A^*$	V_C (V) @ Max I_{PP}^*	I_{PP} (A)*	P_{PK} (W)*	C (pF)
	Max	Max	Min	mA	Typ	Max	Max	Max	Typ
SSESD03C	3.3	2.5	5.0	1.0	9.8	10.4		102	80

*Surge current waveform per Figure 1.

1. V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.

RATINGS AND CHARACTERISTICS CURVES

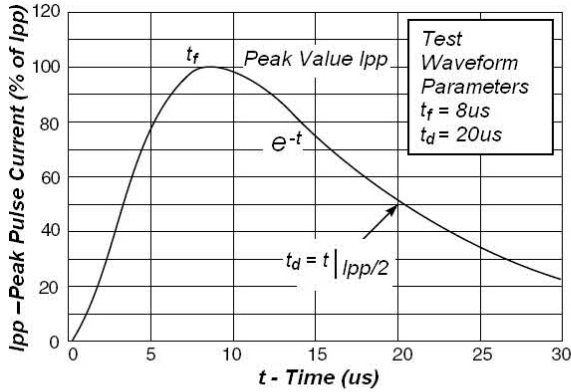


Fig1. Pulse Waveform

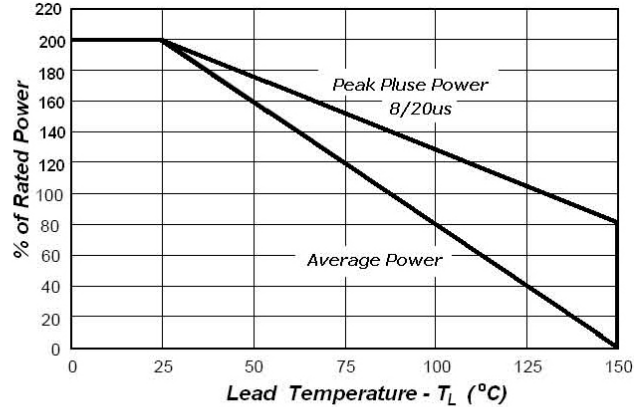


Fig2. Power Derating Curve

APPLICATION NOTE

Electrostatic discharge (ESD) is a major cause of failure in electronic systems. Transient Voltage Suppressors (TVS) are an ideal choice for ESD protection. They are capable of clamping the incoming transient to a low enough level such that damage to the protected semiconductor is prevented.

Surface mount TVS offers the best choice for minimal lead inductance. They serve as parallel protection elements, connected between the signal lines to ground. As the transient rises above the operating voltage of the device, the TVS becomes a low impedance path diverting the transient current to ground. The SSESD03C is the ideal board-level protection of ESD sensitive semiconductor components.

The tiny SOD-923 package allows design flexibility in the design of high density boards where the space saving is at a premium. This enables to shorten the routing and contributes to hardening against ESD.